

Title (en)

PROCESS FOR PRODUCING CERAMIC HONEYCOMB STRUCTURE

Title (de)

VERFAHREN ZUR HERSTELLUNG EINER KERAMIKWABENSTRUKTUR

Title (fr)

PROCÉDÉ DE FABRICATION D'UNE STRUCTURE EN NID D'ABEILLES EN CÉRAMIQUE

Publication

EP 2130808 A4 20141105 (EN)

Application

EP 08712106 A 20080228

Priority

- JP 2008053535 W 20080228
- JP 2007084703 A 20070328

Abstract (en)

[origin: EP2130808A1] 1. A method for producing a ceramic honeycomb structure comprising a ceramic honeycomb body having large numbers of longitudinally extending cells defined by cell walls, and an outer peripheral wall formed on an outer peripheral surface of the ceramic honeycomb body, comprising the steps of applying a coating material comprising colloidal silica having an average particle size of 4-150 nm to longitudinally extending grooves defined by cell on the outer peripheral surface of the ceramic honeycomb body, and induction-drying the coating material to form the outer peripheral wall.

IPC 8 full level

C04B 41/85 (2006.01); **B01D 39/00** (2006.01); **B01D 39/20** (2006.01); **B01D 46/00** (2006.01); **B01D 46/24** (2006.01); **B01J 35/04** (2006.01); **C04B 41/00** (2006.01); **C04B 41/50** (2006.01); **C04B 41/87** (2006.01); **F01N 3/022** (2006.01); **F01N 3/28** (2006.01); **C04B 111/00** (2006.01)

CPC (source: EP US)

B01D 46/0001 (2013.01 - EP US); **B01D 46/2418** (2013.01 - EP US); **B01J 35/56** (2024.01 - EP US); **C04B 41/009** (2013.01 - EP US); **C04B 41/5024** (2013.01 - EP US); **C04B 41/87** (2013.01 - EP US); **B01D 46/2462** (2013.01 - US); **B01D 46/2482** (2021.08 - EP US); **B01D 2279/30** (2013.01 - EP US); **C04B 2111/00793** (2013.01 - EP US); **C04B 2111/0081** (2013.01 - EP US); **F01N 3/0222** (2013.01 - EP US); **F01N 3/2828** (2013.01 - EP US); **F01N 2260/10** (2013.01 - EP US); **F01N 2330/06** (2013.01 - EP US); **F01N 2510/06** (2013.01 - EP US)

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